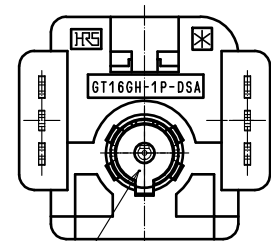


ELV, RoHS COMPLIANT



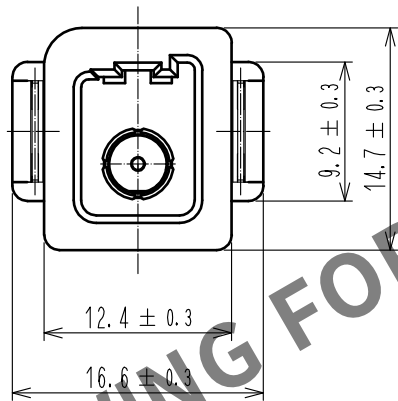
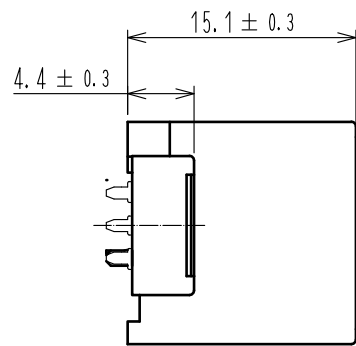
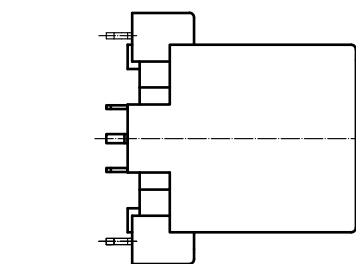
4 INSULATOR

CENTER CONTACT 2

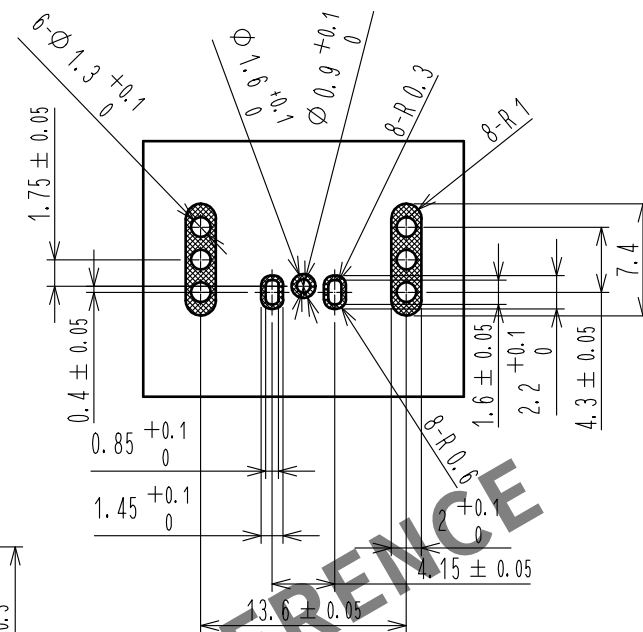
OUTER CONDUCTOR 3

METAL PEG 5

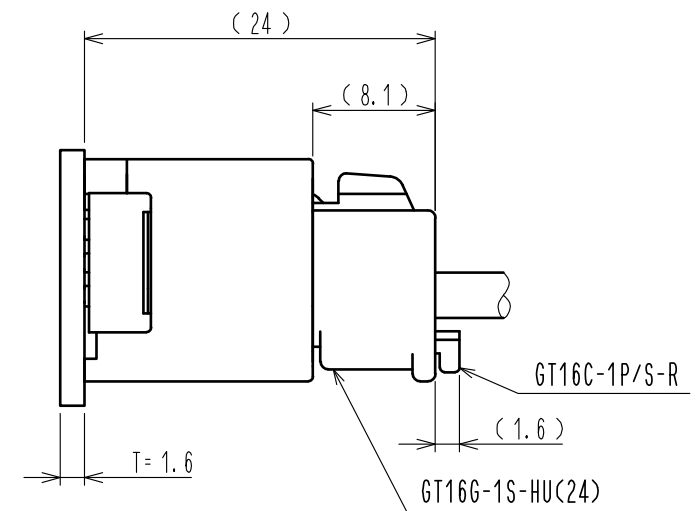
1 HOUSING



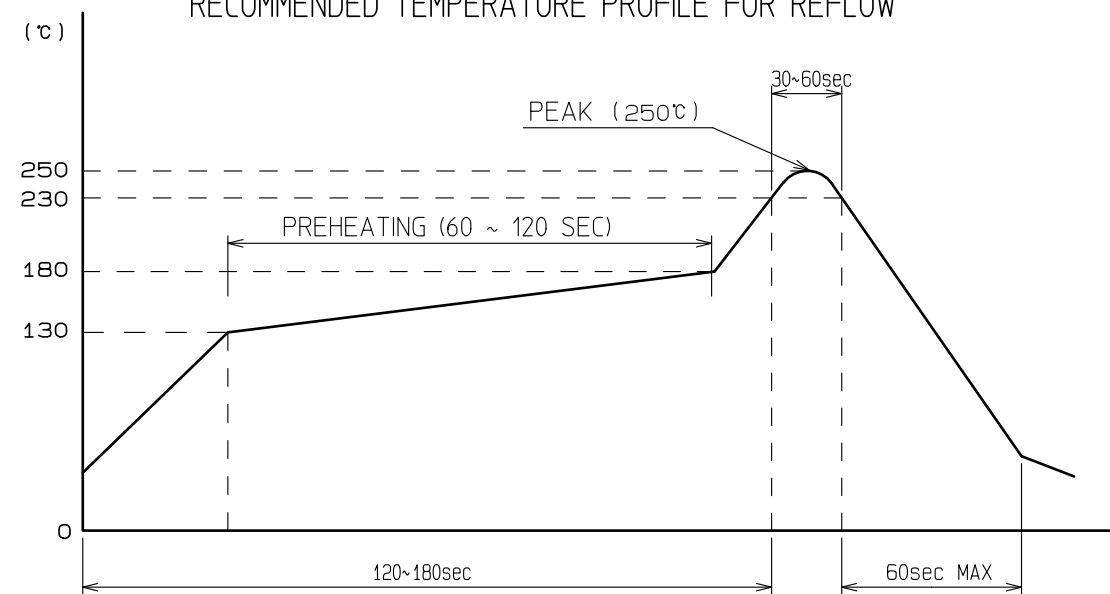
RECOMMENDED PC BOARD PATTERN



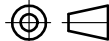
MATED CONNECTORS



RECOMMENDED TEMPERATURE PROFILE FOR REFLOW



Note1. THE RECOMMENDED REFLOW TEMPERATURE PROFILE IS AS FIGURE.
2. RECOMMENDED PCB THICKNESS IS 1.6mm.
3. PACKING STYLE REFERS TO ATAP-T0507-00.

3	PHOSPHOR BRONZE	TIN PLATING							
2	PHOSPHOR BRONZE	TIN PLATING	5	BRASS	TIN PLATING				
1	PPS	BLACK	4	PPS	NATURAL				
NO.	MATERIAL	FINISH . REMARKS		NO.	MATERIAL	FINISH . REMARKS			
UNITS mm		SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : KI. HIROKAWA		18. 04. 17	DRAWING NO. EDC-359267-00-00				
		CHECKED : MO. OKADA		18. 04. 12	PART NO. GT16GH-1P-DSA				
		DESIGNED : AM. YAMAUCHI		18. 04. 10	CODE NO. CL766-0112-3-00				
		DRAWN : MN. SATOH		18. 03. 30	 1/1				